# LEAD TINNING MACHINES

CELEBRATING MORE THAN 25 YEARS IN THE AUTOMATED SOLDERING INDUSTRY



# HENTES RPS



Proudly made in the USA

## LEAD TINNING MACHINES

**Purpose:** 

**Performance:** 

Footprint: Stations: Solder Capacity: Static Range: Dynamic Range: Flux Static Range: **Mid Volume Production** Manual Load **High Precision** High Repeatability 67 x 29 x 29" (L x Ŵ x H) Up to 4 Stations 2 x 40 lbs | 2 x 18.1 kgs 5 x 8 x 4" | 125 x 200 x 100 mm 4 x 4 x 2.5" | 100 x 100 x 64 mm 4 x 4 x 2.5" | 100 x 100 x 64 mm



**Purpose:** 

**Performance:** 

Footprint: Stations: Solder Capacity: Static Range: Dynamic Range: Flux Static Range:

**High Volume High Mix Capacity High Precision** High Repeatability 99 x 53 x 64" (L x Ŵ x H) Up to 6 Stations 280 lbs | 127 kgs 5 x 8 x 4'' | 125 x 200 x 100 mm 5 x 8 x 2.5" | 127 x 200 x 64 mm 5 x 8 x 2.5" | 127 x 200 x 64 mm 3rd Station Preheat: Standard | 4 x 8" (W x L)



**Purpose:** 

Performance:

Footprint: Stations: Solder Capacity: Static Range: Dynamic Range: Flux Static Range:

**High Volume** High Mix Capacity Dual Alloy Capable **High Precision High Repeatability** 123 x 53 x 64" (L x W x H) Up to 8 Stations 280 lbs | 127 kgs 5 x 8 x 4<sup>''</sup> | 125 x 200 x 100 mm 5 x 8 x 2.5<sup>''</sup> | 127 x 200 x 64 mm 5 x 8 x 2.5" | 127 x 200 x 64 mm **3rd Station Preheat:** Standard | 4 x 8" (W x L)



## STANDARD FEATURES

Steel welded frame Integrated computer Unlimited programs Interpolated X and Z rotation motion control PID temperature control Low dross/ low maintenance High repeatability Lead free compatible High Precision ± .002" (0.025 mm) CE certified Mill spec compliant Two year system warranty Four year solder pot warranty

### ADDITIONAL OPTIONS

Single or multi-pot stations Dynamic or static solder bath Dynamic or static flux bath Preheat station Rotary Vacuum N<sub>2</sub> insertion Extended warranty Auto load/unload (Odyssey 1325 and 1750 only) Dual DSP (Odyssey 1750 only) Dual flux (Odyssey 1750 only) Dual alloy capable (Odyssey 1750 only)

For over 25 years, Hentec Industries has been advancing lead tinning and soldering technology for the military, aerospace, and the commercial micro-electronics component industry. Hentec lead tinning systems are automated, hands-free robotic platforms, designed to tin component leads for re-conditioning and re-tinning applications, including high reliability and military application. Lead tinning systems are suitable for DIP, SIP, QFP, BGA, axial transistor, radial components, and more. Hentec offers several models of the Odyssey system. Each model provides increasing scale and features for higher production volumes and component capacity. Standard features include flux and solder stations, configurable for multiple solder stations, preheat, dynamic or static solder baths, dynamic or static dip flux baths, and rinse and dry stations. Hentec software provides total control to set all process parameters, including immersion depths, dwell times, impeller speeds, insertion and extraction speed acceleration, and all I/O. All systems are designed to meet the needs of small lot batch processing as well as high volume production. Option availability is extensive and includes dynamic or static solder pots, multiple dip stations, dip or drag solder nozzles, standard and custom component tool holders, hot N2 air knife, and much more.



#### LEAD TINNING STANDARDS AND COMPLIANCE



Hentec lead tinning machines are used for lead stripping, tinning of SMT, through-hole RoHS and tin/lead components. The growth of tin whiskers has re-emerged as a threat to the health and safety of electronic systems worldwide with the introduction of RoHS compliant electronic components. Governments and industry have joined together to develop a standard for the replacement on tin only finishes with a proven tin/lead solder. That standard, GEIA-STD-006, provides for a highly controlled robotic hot solder dip that replaces the tin only finish with a tin/lead finish. Hentec provides leadership in meeting the industry and military solderability cleanliness compliance requirements configuration) (depending on for: GEIA-STD-006, MIL-PRF-38535, MIL-PRF-38534E, and ANSI-J-STD-002.

#### SUCCESS IN THE FIELD

"Thanks again. I have never seen a company with such great customer service." - Josh Wilson, 4 Star Electronics

"We selected Hentec over several other vendors. The company showed the expertise and the commitment to meet our specific requirements. The Hentec lead tinning system is a great addition to our production environment."

- Lead Tinning Manager, Honeywell



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